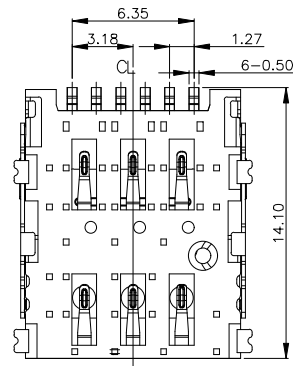
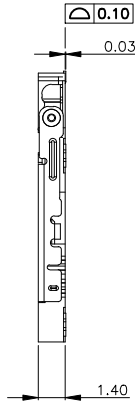
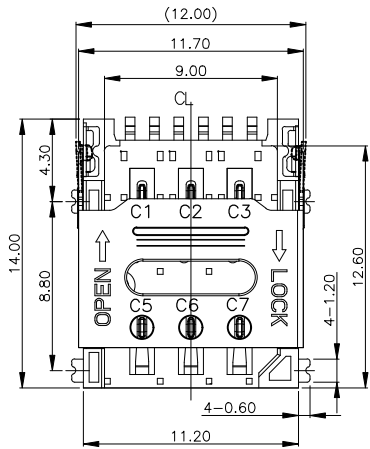
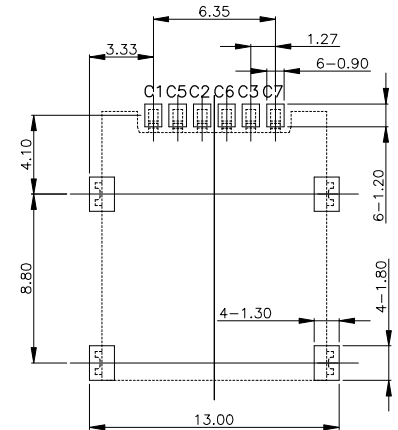
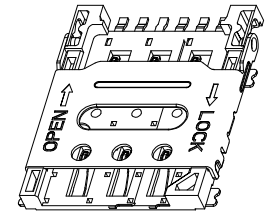




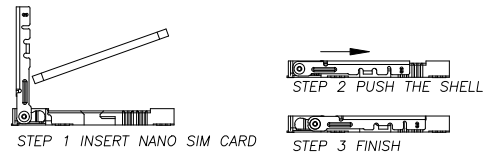
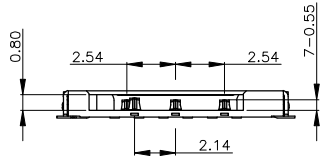
REV.	ECN NO OR DESCRIPTION	REVISED	DATE



- NOTES:
- MATERIAL:
 - Housing: High Temperature Thermoplastic UL94V-0; Color Black.
 - Terminal: Copper Alloy, T=0.12mm.
 - Shell: Stainless Steel, T=0.20mm.
 - FINISH:
 - Terminal: Plated Gold on the Contact Area and Solder Tails
 - Peg: Plated Gold on the Solder Tails.
 - SPECIALITY:
 - Rated current: 0.5A
 - Rated voltage: 50V
 - Contact Resistance: 80mΩ MAX
 - Insulation Resistance: 100MΩ MIN 100V DC
 - Dielectric withstanding voltage: 100V AC.
 - Solder ability: 245±5°C, 5±0.5s.
 - Operating condition: Temperature: -30°C ~ +80°C Humidity: 80% R.H MAX

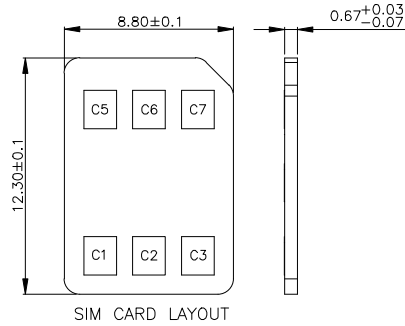
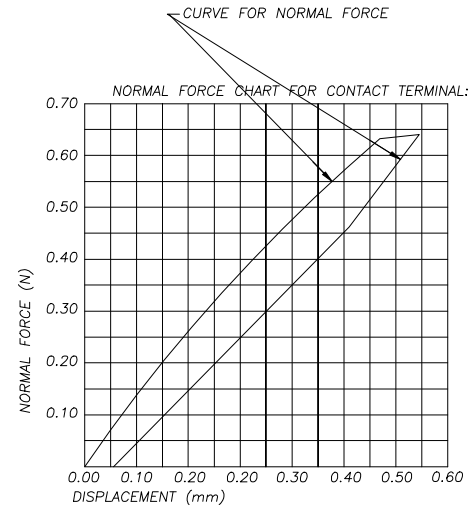


RECOMMENDED PCB LAYOUT TOP VIEW (TOLERANCE:±0.05)
RECOMMENDED MATAI MASK T=0.12MM



【 SIM Card Pin Assignments 】

PIN	Name
C1	Vcc
C2	RST
C3	CLK
C4	Reserved
C5	GND
C6	Vpp
C7	I/O
C8	Reserved



③	TERMINAL	6	C5210-EH, T=0.12	Au 3u" PLATING
②	BASE INSULATOR	1	LCP+GF30%	BLACK
①	SHELL	1	SUS304-H, T=0.15	AU/Ni PLATING
NO.	PART NAME	Q'TY	DESCRIPTION	NOTE
UNLESS OTHERWISE SPECIFIED TOLERANCES		东莞市汉博电子科技有限公司 DONGGUAN HANBO TECHNOLOGY CO., LTD		
DECIMALS: X :±0.5 X.X :±0.20 X.XX :±0.10		ANGLES: X :±2° X.X :±1° TITLE: 6Pin 1.4H Hinge Nano SIM CARD CONN. DWN: xiong PART NO. SNO-1330 CHKD: lee SCALE: 1:1 UNIT: mm APVD: wang SIZE: A4 SHEET: 10F 1 REV: A4 CUSTOMER COPY		